



SN74HC/HCT01 (LX)

Quad 2-Input Nand Gate with Open-Drain Outputs

Product Specification

Specification Revision History:

Version	Date	Description
2023-11-A0	2023-11	New
2024-02-A1	2024-02	Modify the parameters



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1、General Description

The SN74HC/HCT01 contains four independent 2-input NAND Gates with open-drain outputs.

Features:

- Supply voltage range:
SN74HC01: 2V to 6V
SN74HCT01: 4.5V to 5.5V
- Input levels:
SN74HC01: CMOS level
SN74HCT01: TTL level
- Temperature range:-40°C to +125°C
- Packaging information: DIP14/SOP14/TSSOP14

Ordering Information:

Tube packing specifications:

Part number	Packaging form	Marking code	Tube quantity	Boxed tube quantity	Boxed quantity	Notes
SN74HC01N (LX)	DIP14	SN74HC01N	25 PCS/tube	40 tube/box	1000 PCS/box	Dimensions of plastic enclosure: 19.0mm×6.4mm Pin spacing: 2.54mm
SN74HCT01N (LX)	DIP14	SN74HCT01N	25 PCS/tube	40 tube/box	1000 PCS/box	Dimensions of plastic enclosure: 19.0mm×6.4mm Pin spacing: 2.54mm
SN74HC01D(LX)	SOP14	HC01	50 PCS/tube	200 tube/box	10000 PCS/box	Dimensions of plastic enclosure: 8.7mm×3.9mm Pin spacing: 1.27mm
SN74HCT01D (LX)	SOP14	HCT01	50 PCS/tube	200 tube/box	10000 PCS/box	Dimensions of plastic enclosure: 8.7mm×3.9mm Pin spacing: 1.27mm
SN74HC01P (LX)	TSSOP14	HC01	96 PCS/tube	200 tube/box	19200 PCS/box	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing: 0.65mm
SN74HCT01P (LX)	TSSOP14	HCT01	96 PCS/tube	200 tube/box	19200 PCS/box	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing: 0.65mm



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Reel packing specifications:

Part number	Packaging form	Marking code	Reel quantity	Boxed reel quantity	Notes
SN74HC01DR (LX)	SOP14	HC01	2500 PCS/reel	5000 PCS/box	Dimensions of plastic enclosure: 8.7mm×3.9mm Pin spacing: 1.27mm
SN74HCT01DR (LX)	SOP14	HCT01	4000 PCS/reel	8000 PCS/box	Dimensions of plastic enclosure: 8.7mm×3.9mm Pin spacing: 1.27mm
SN74HC01PW (LX)	TSSOP14	74HC01	5000 PCS/reel	10000 PCS/box	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing: 0.65mm
SN74HCT01PW (LX)	TSSOP14	74HCT01	5000 PCS/reel	10000 PCS/box	Dimensions of plastic enclosure: 5.0mm×4.4mm Pin spacing: 0.65mm

Note: If the physical information is inconsistent with the ordering information, please refer to the actual product.



2、Block Diagram And Pin Description

2.1、Block Diagram

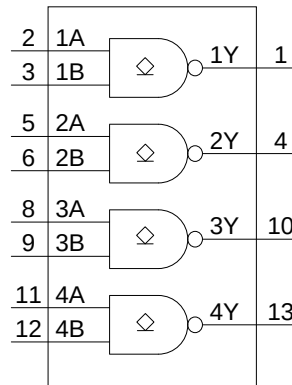


Figure 1. Logic symbol

2.2、Pin Configurations

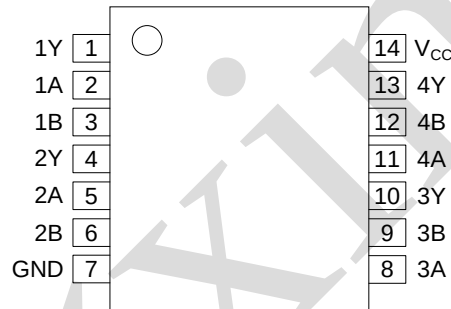


Figure 2. Pin Configurations

2.3、Pin Description

Pin No.	Pin Name	Description
1	1Y	data output
2	1A	data input
3	1B	data input
4	2Y	data output
5	2A	data input
6	2B	data input
7	GND	ground (0V)
8	3A	data input
9	3B	data input
10	3Y	data output
11	4A	data input
12	4B	data input
13	4Y	data output
14	V _{CC}	supply voltage



2.4、Function Table

Input		Output
nA	nB	nY
L	L	Z
L	H	Z
H	L	Z
H	H	L

Note: L=LOW voltage level; Z=high-impedance OFF-state.

3、Electrical Parameter

3.1、Absolute Maximum Ratings

(Voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	Conditions	Min.	Max.	Unit
supply voltage	V_{CC}	-	-0.5	+7	V
supply current	I_{CC}	-	-	50	mA
ground current	I_{GND}	-	-50	-	mA
input clamping current	I_{IK}	$V_I < -0.5V$ or $V_I > V_{CC}+0.5V$	-	± 20	mA
output clamping current	I_{OK}	$V_O < -0.5V$ or $V_O > V_{CC}+0.5V$	-	± 20	mA
output current	I_O	$-0.5V < V_O < V_{CC}+0.5V$	-	± 25	mA
storage temperature	T_{stg}	-	-65	+150	$^{\circ}C$
soldering temperature	T_L	10s	DIP		245
			SOP/TSSOP		260

3.2、Recommended Operating Conditions

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
SN74HC01						
supply voltage	V_{CC}	-	2.0	5.0	6.0	V
input voltage	V_I	-	0	-	V_{CC}	V
output voltage	V_O	-	0	-	V_{CC}	V
ambient temperature	T_{amb}	-	-40	-	+125	$^{\circ}C$
SN74HCT01						
supply voltage	V_{CC}	-	4.5	5.0	5.5	V
input voltage	V_I	-	0	-	V_{CC}	V
output voltage	V_O	-	0	-	V_{CC}	V
ambient temperature	T_{amb}	-	-40	-	+125	$^{\circ}C$



3.3、Electrical Characteristics

3.3.1、DC Characteristics 1

($T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	V_{CC}	Conditions	Min.	Typ.	Max.	Unit
SN74HC01							
HIGH-level input voltage	V_{IH}	2.0V	-	1.5	1.2	-	V
		4.5V	-	3.15	2.4	-	V
		6.0V	-	4.2	3.2	-	V
LOW-level input voltage	V_{IL}	2.0V	-	-	0.8	0.5	V
		4.5V	-	-	2.1	1.35	V
		6.0V	-	-	2.8	1.8	V
LOW-level output voltage	V_{OL}	2.0V	$I_O = 20\mu\text{A}$	-	0	0.1	V
		4.5V	$I_O = 20\mu\text{A}$	-	0	0.1	V
		6.0V	$I_O = 20\mu\text{A}$	-	0	0.1	V
		4.5V	$I_O = 4.0\text{mA}$	-	0.15	0.33	V
		6.0V	$I_O = 5.2\text{mA}$	-	0.16	0.33	V
input leakage current	I_I	6.0V	$V_I = V_{CC}$ or GND	-	-	± 1	μA
OFF-state output current	I_{OZ}	6.0V	$V_I = V_{IH}$ or V_{IL} ; $V_O = V_{CC}$ or GND	-	-	± 5	μA
supply current	I_{CC}	6.0V	$V_I = V_{CC}$ or GND; $I_O = 0\text{A}$	-	-	10	μA
SN74HCT01							
HIGH-level input voltage	V_{IH}	4.5~5.5V	-	2.0	1.6	-	V
LOW-level input voltage	V_{IL}	4.5~5.5V	-	-	1.2	0.8	V
LOW-level output voltage	V_{OL}	4.5V	$I_O = 20\mu\text{A}$	-	0	0.1	V
			$I_O = 4.0\text{mA}$	-	0.15	0.33	V
input leakage current	I_I	5.5V	$V_I = V_{CC}$ or GND	-	-	± 1	μA
OFF-state output current	I_{OZ}	5.5V	$V_I = V_{IH}$ or V_{IL} ; $V_O = V_{CC}$ or GND	-	-	± 5	μA
supply current	I_{CC}	5.5V	$V_I = V_{CC}$ or GND; $I_O = 0\text{A}$	-	-	80	μA
additional supply current	ΔI_{CC}	4.5~5.5V	One input at $V_I = V_{CC} - 2.1\text{V}$; Other inputs at V_{CC} or GND; $I_O = 0\text{A}$	-	-	135	μA



3.3.2、DC Characteristics 2

($T_{amb} = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	V_{CC}	Conditions	Min.	Typ.	Max.	Unit
SN74HC01							
HIGH-level input voltage	V_{IH}	2.0V	-	1.5	-	-	V
		4.5V	-	3.15	-	-	V
		6.0V	-	4.2	-	-	V
LOW-level input voltage	V_{IL}	2.0V	-	-	-	0.5	V
		4.5V	-	-	-	1.35	V
		6.0V	-	-	-	1.8	V
LOW-level output voltage	V_{OL}	2.0V	$I_O = 20\mu\text{A}$	-	-	0.1	V
		4.5V	$I_O = 20\mu\text{A}$	-	-	0.1	V
		6.0V	$I_O = 20\mu\text{A}$	-	-	0.1	V
		4.5V	$I_O = 4.0\text{mA}$	-	-	0.4	V
		6.0V	$I_O = 5.2\text{mA}$	-	-	0.4	V
input leakage current	I_I	6.0V	$V_I = V_{CC}$ or GND	-	-	± 1	μA
OFF-state output current	I_{OZ}	6.0V	$V_I = V_{IH}$ or V_{IL} ; $V_O = V_{CC}$ or GND	-	-	± 10	μA
supply current	I_{CC}	6.0V	$V_I = V_{CC}$ or GND; $I_O = 0\text{A}$	-	-	160	μA
SN74HCT01							
HIGH-level input voltage	V_{IH}	4.5~5.5V	-	2.0	-	-	V
LOW-level input voltage	V_{IL}	4.5~5.5V	-	-	-	0.8	V
LOW-level output voltage	V_{OL}	4.5V	$I_O = 20\mu\text{A}$	-	-	0.1	V
			$I_O = 4.0\text{mA}$	-	-	0.4	V
input leakage current	I_I	5.5V	$V_I = V_{CC}$ or GND	-	-	± 1	μA
OFF-state output current	I_{OZ}	5.5V	$V_I = V_{IH}$ or V_{IL} ; $V_O = V_{CC}$ or GND	-	-	± 10	μA
supply current	I_{CC}	5.5V	$V_I = V_{CC}$ or GND; $I_O = 0\text{A}$	-	-	160	μA
additional supply current	ΔI_{CC}	4.5~5.5V	One input at $V_I = V_{CC} - 2.1\text{V}$; Other inputs at V_{CC} or GND; $I_O = 0\text{A}$	-	-	147	μA



3.3.3、AC Characteristics 1

($T_{amb} = -40^{\circ}\text{C}$ to $+85^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	V _{CC}	Conditions	Min.	Typ.	Max.	Unit	
SN74HC01								
propagation delay	t _{PLZ} , t _{PZL}	2.0V	C _L =50pF	see Figure 4	-	41	155	ns
		4.5V	C _L =50pF		-	15	23	ns
		5.0V	C _L =15pF		-	12	-	ns
		6.0V	C _L =50pF		-	12	20	ns
transition time	t _{THL}	2.0V	C _L =50pF	see Figure 4	-	19	95	ns
		4.5V	C _L =50pF		-	7	19	ns
		6.0V	C _L =50pF		-	6	16	ns
SN74HCT01								
propagation delay	t _{PLZ} , t _{PZL}	4.5V	C _L =50pF	see Figure 4	-	20	43	ns
		5.0V	C _L =15pF		-	17	-	ns
transition time	t _{THL}	4.5V	C _L =50pF	see Figure 4	-	7	19	ns

3.3.4、AC Characteristics 2

($T_{amb} = -40^{\circ}\text{C}$ to $+125^{\circ}\text{C}$, voltages are referenced to GND (ground=0V), unless otherwise specified.)

Parameter	Symbol	V _{CC}	Conditions	Min.	Typ.	Max.	Unit	
SN74HC01								
propagation delay	t _{PLZ} , t _{PZL}	2.0V	C _L =50pF	see Figure 4	-	-	190	ns
		4.5V	C _L =50pF		-	-	38	ns
		6.0V	C _L =50pF		-	-	32	ns
transition time	t _{THL}	2.0V	C _L =50pF	see Figure 4	-	-	110	ns
		4.5V	C _L =50pF		-	-	22	ns
		6.0V	C _L =50pF		-	-	19	ns
SN74HCT01								
propagation delay	t _{PLZ} , t _{PZL}	4.5V	C _L =50pF	see Figure 4	-	-	51	ns
transition time	t _{THL}	4.5V	C _L =50pF	see Figure 4	-	-	22	ns



4、Testing Circuit

4.1、AC Testing Circuit

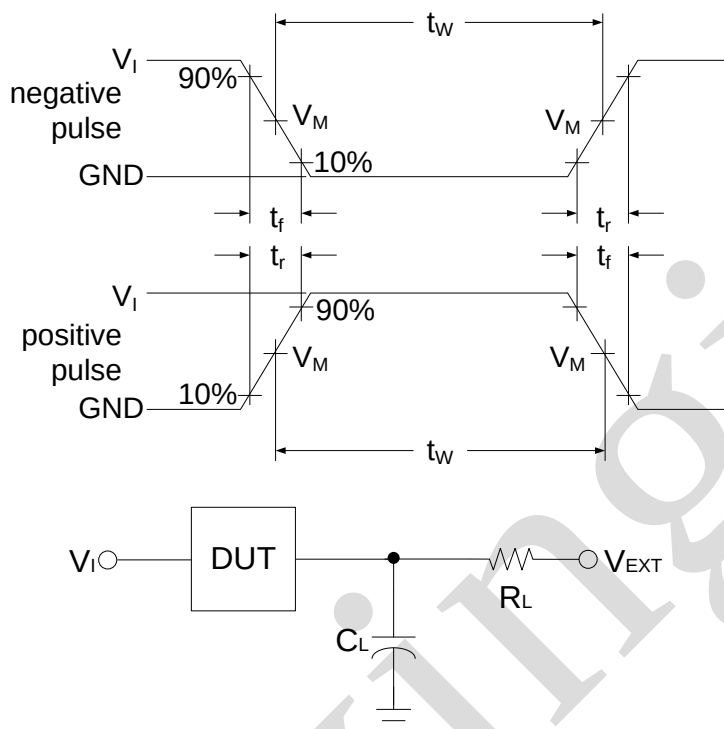


Figure 3. Test circuit for measuring switching times

C_L includes probe and jig capacitance.

4.2、Test Data

Type	Input		Load		V_{EXT}		
	V_I	$t_r = t_f$	C_L	R_L	t_{PLH}/t_{PHL}	t_{PLZ}/t_{PZL}	t_{PHZ}/t_{PZH}
SN74HC01	V_{CC}	3.0ns	15pF, 50pF	1K Ω	Open	V_{CC}	GND
SN74HCT01	3.0V	3.0ns	15pF, 50pF	1K Ω	Open	V_{CC}	GND



4.3、AC Testing Waveforms

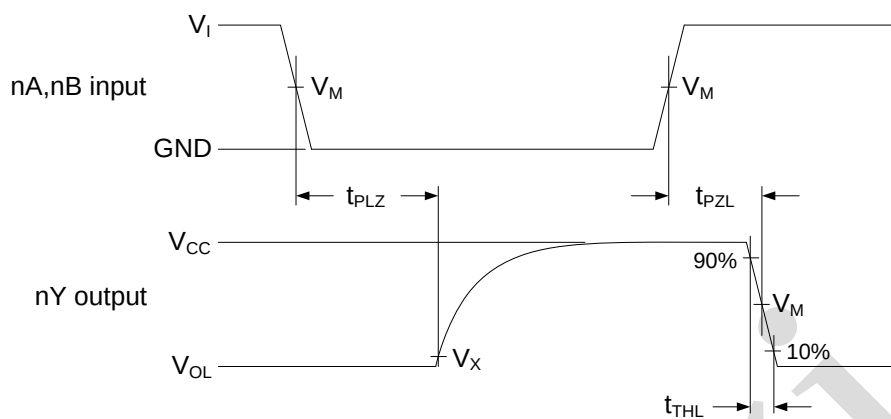


Figure 4. Input to output propagation delays

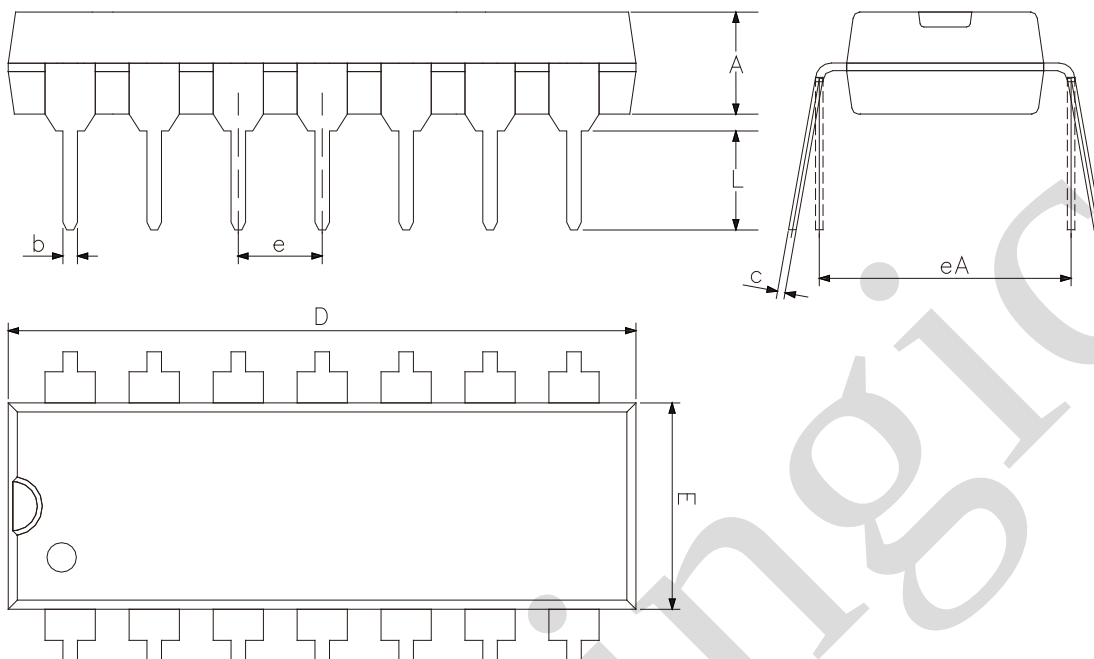
4.4、Measurement Points

Type	Input	Output	
	V_M	V_M	V_X
SN74HC01	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$0.1 \times V_{CC}$
SN74HCT01	1.3V	1.3V	$0.1 \times V_{CC}$



5、Package Information

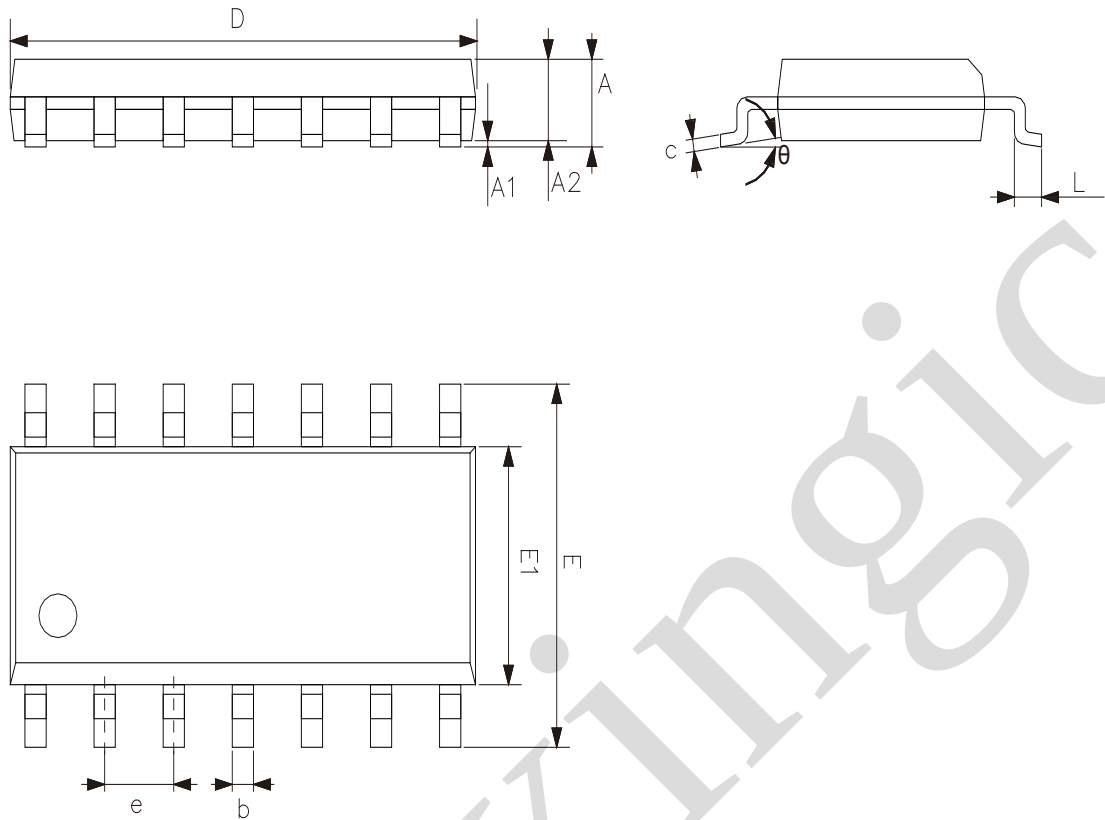
5.1、DIP14



2023/12/A	Dimensions In Millimeters	
Symbol	Min	Max
A	3.05	3.60
b	0.33	0.56
c	0.20	0.36
D	18.80	19.40
E	6.20	6.60
e	2.54	
eA	7.62	10.90
L	2.92	—



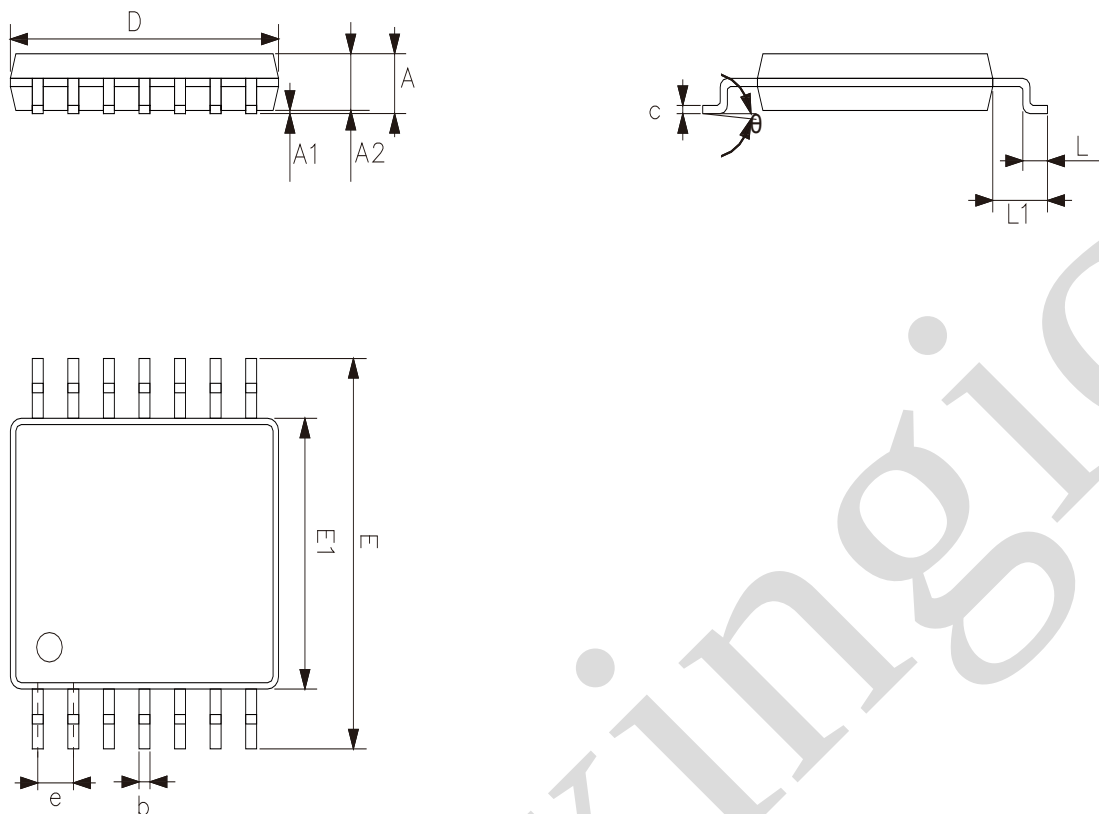
5.2、SOP14



2023/12/A	Dimensions In Millimeters	
Symbol	Min.	Max.
A	1.50	1.75
A1	0.05	0.25
A2	1.30	—
b	0.33	0.50
c	0.19	0.25
D	8.43	8.76
E	5.80	6.25
E1	3.75	4.00
e	1.27	
L	0.40	0.89
θ	0°	8°



5.3、TSSOP14



2023/12/A	Dimensions In Millimeters	
Symbol	Min	Max
A	—	1.20
A1	0.05	0.15
A2	0.80	1.05
b	0.19	0.30
c	0.09	0.20
D	4.90	5.10
E1	4.30	4.50
E	6.20	6.60
e	0.65	
L	0.45	0.75
L1	1.00	
θ	0°	8°



6、Statements And Notes

6.1、The name and content of Hazardous substances or Elements in the product

Part name	Hazardous substances or Elements									
	Lead and lead compounds	Mercury and mercury compounds	Cadmium and cadmium compounds	Hexavalent chromium compounds	Polybrominated biphenyls	Polybrominated biphenyl ethers	Dibutyl phthalate	Butylbenzyl phthalate	Di-2-ethylhexyl phthalate	Diisobutyl phthalate
Lead frame	○	○	○	○	○	○	○	○	○	○
Plastic resin	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
The lead	○	○	○	○	○	○	○	○	○	○
Plastic sheet installed	○	○	○	○	○	○	○	○	○	○
explanation	○: Indicates that the content of hazardous substances or elements in the detection limit of the following the SJ/T11363-2006 standard. ×: Indicates that the content of hazardous substances or elements exceeding the SJ/T11363-2006 Standard limit requirements.									

6.2、Notes

We recommend you to read this chapter carefully before using this product.

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